

L Number	Hits	Search Text	DB	Time stamp
1	71	(coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (Tg or "T.sub.g")	USPAT; US-PGPUB	2004/08/30 08:14
2	86	(coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	USPAT; US-PGPUB	2004/08/30 08:39
3	5	(stress\$3) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	USPAT; US-PGPUB	2004/08/30 08:31
4	1	(relax\$7) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	USPAT; US-PGPUB	2004/08/30 08:28
5	968	(coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near4 (soften\$4)	USPAT; US-PGPUB	2004/08/30 08:29
6	18	(coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near4 (soften\$4) with (Tg or "T.sub.g" or (glass near2 transition))	USPAT; US-PGPUB	2004/08/30 08:29
7	0	(stress\$3 or relax\$7) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	EPO; JPO; DERWENT; IBM_TDB	2004/08/30 08:32
8	32	(coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)	EPO; JPO; DERWENT; IBM_TDB	2004/08/30 08:38
9	467	resistor with TCR	USPAT; US-PGPUB	2004/08/30 08:39
10	415	((cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))	USPAT; US-PGPUB	2004/08/30 08:41
11	329	((cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))) not ((coat\$3 or deposit\$3 or apply\$3 or film or layer) with (cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition))	USPAT; US-PGPUB	2004/08/30 08:40
12	58	((cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)) same (stamp\$5 or pattern\$4 or press\$3 or die or emboss\$5)	USPAT; US-PGPUB	2004/08/30 08:44
13	13	((cure or cured or curing or harden\$3 or polymeriz\$6) near3 (higher or above or greater or hotter) near3 (glass near2 transition)) same (stamp\$5 or pattern\$4 or press\$3 or die or emboss\$5)	EPO; JPO; DERWENT; IBM_TDB	2004/08/30 08:45
14	11	(spincoat\$3 or (spin adj coat\$3)) with (resin\$5 or monomer\$3 or prepolymer\$4 or solution or liquid) with (temperature) with (lower or below or under) near4 (cure or cured or curing or polymeriz\$6 or harden\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/30 08:53
15	12	(spincoat\$3 or (spin adj coat\$3)) with (temperature) near3 (lower or below or under) near4 (cure or cured or curing or polymeriz\$6 or harden\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/30 08:54

16	775	(coat\$3 or deposit\$3 or apply\$3) near4 (temperature) near3 (lower or below or under) near3 (cure or cured or curing or polymeriz\$6 or harden\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:00
17	13	(stamp\$3 with substrate with (alignment adj mark\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:07
18	0	(stamp\$3 with pattern\$4 with (inert) with (vacuum or (low\$2 adj pressure) or (reduc\$5 near2 pressure)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:09
19	14	(stamp\$3 with (inert) with (vacuum or (low\$2 adj pressure) or (reduc\$5 near2 pressure)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:10
20	1	(stamp\$3 with (vacuum or (low\$2 adj pressure) or (reduc\$5 near2 pressure))) and ((427/277).ccls. or (427/278).ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:37
21	1344455	(stamp\$3 with pattern\$3 (vacuum or (low\$2 adj pressure) or (reduc\$5 near2 pressure)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:12
22	117	(stamp\$3 with pattern\$3 with (vacuum or (low\$2 adj pressure) or (reduc\$5 near2 pressure)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:17
23	68	(stamp\$3 with (vacuum adj chamber))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:28
24	74	(stamp\$3 with (inert adj gas))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:40
25	0	(stamp\$3 same (inert)) and ((427/277).ccls. or (427/278).ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:38
26	9	((inert adj gas)) and ((427/277).ccls. or (427/278).ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:38
27	171	(stamp\$3 with (inert))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:40
28	97	((stamp\$3 with (inert))) not ((stamp\$3 with (inert adj gas)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:43
29	2	6409565.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 09:43
-	2	6759182.pn. or 6774964.pn.	USPAT; US-PGPUB	2004/08/25 13:43

-	4	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)	USPAT; US-PGPUB	2004/08/25 13:54
-	3	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)	EPO; JPO; DERWENT; IBM_TDB	2004/08/25 13:50
-	4	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)) and (glass near2 transition) and (decomposition)	USPAT; US-PGPUB	2004/08/25 13:57
-	1	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature same (polymeriz\$5 or cure or curing or cured) same (glass near3 transition) same (decomposition))	USPAT; US-PGPUB	2004/08/25 13:55
-	0	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (polymeriz\$5 or cure or curing or cured) and (glass near3 transition) and (decomposition))	EPO; JPO; DERWENT; IBM_TDB	2004/08/25 13:57
-	6	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (glass near3 transition) and (decomposition))	EPO; JPO; DERWENT; IBM_TDB	2004/08/25 13:56
-	54	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (temperature and (polymeriz\$5 or cure or curing or cured) and (glass near3 transition))	EPO; JPO; DERWENT; IBM_TDB	2004/08/25 13:57
-	4	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and ((micro adj asperity) or microasperity)) and (reflect\$4 near3 (LCD or (liquid adj crystal\$4 adj display)))	USPAT; US-PGPUB	2004/08/25 13:58
-	63	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect\$4 near3 (LCD or (liquid adj crystal\$4 adj display)))	USPAT; US-PGPUB	2004/08/25 14:08
-	19	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect\$4 near3 (LCD or (liquid adj crystal\$4 adj display)))) and ((pattern or groove or plate) with (stamp\$2 or roll\$3 or die))	USPAT; US-PGPUB	2004/08/25 13:59
-	19	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect\$4 near3 (LCD or (liquid adj crystal\$4 adj display)))) and ((pattern or groove or plate or asperity or microasperity) with (stamp\$2 or roll\$3 or die))	USPAT; US-PGPUB	2004/08/25 14:09
-	76	(Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect\$4 near3 (LCD or (liquid adj crystal\$4 adj display)))	EPO; JPO; DERWENT; IBM_TDB	2004/08/25 14:09
-	3	((Ikeda.in. or Funamoto.in. or Matsushita.in. or Aoyama.in. or Omron.as.) and (reflect\$4 near3 (LCD or (liquid adj crystal\$4 adj display)))) and ((pattern or groove or plate or asperity or microasperity) with (stamp\$2 or roll\$3 or die))	EPO; JPO; DERWENT; IBM_TDB	2004/08/25 14:27
-	2522	(427/162,163.1,164,165).CCLS.	USPAT; US-PGPUB	2004/08/25 14:28
-	446	(427/271).CCLS.	USPAT; US-PGPUB	2004/08/25 14:28
-	523	(427/277,278).CCLS.	USPAT; US-PGPUB	2004/08/25 14:28

-	523	(427/277,278).CCLS.	USPAT; US-PGPUB	2004/08/27 10:00
-	16	((427/277,278).CCLS.) and (glass adj transition)	USPAT; US-PGPUB	2004/08/27 10:11
-	931	((coat\$3 or deposit\$3 or apply\$3 or application or spincoat\$3) with (temperature) with (lower or below or under) with ((polymeriz\$5 or curing) near3 temperature))	USPAT; US-PGPUB	2004/08/27 10:16
-	0	((coat\$3 or deposit\$3 or apply\$3 or application or spincoat\$3) with (temperature) with (lower or below or under) with ((polymeriz\$5 or curing) near3 temperature))) and ((427/277,278).CCLS.)	USPAT; US-PGPUB	2004/08/27 10:15
-	74	((coat\$3 or deposit\$3 or apply\$3 or application or spincoat\$3) with (temperature) with (lower or below or under) with ((polymeriz\$5 or curing) near3 temperature))) and ((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277,278).CCLS.) ((427/372.2,374.1,375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.)	USPAT; US-PGPUB	2004/08/27 10:15
-	40	((coat\$3 or deposit\$3 or apply\$3 or application or spincoat\$3) with (temperature) with (lower or below or under) with ((polymeriz\$5 or curing or reaction) near3 temperature)) and ((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near6 (glass adj transition)))	USPAT; US-PGPUB	2004/08/27 10:21
-	1	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((427/277,278).CCLS.)	USPAT; US-PGPUB	2004/08/27 10:22
-	3	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex))	USPAT; US-PGPUB	2004/08/27 10:24
-	51	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex))	USPAT; US-PGPUB	2004/08/27 10:30
-	48	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex))) not ((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex)))	USPAT; US-PGPUB	2004/08/27 10:25
-	2	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex))	EPO; JPO; DERWENT; IBM_TDB	2004/08/27 10:29

-	189	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master or emboss\$5))	USPAT; US-PGPUB	2004/08/27 11:04
-	168	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master or emboss\$5)) not (((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex))) not ((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex)))	USPAT; US-PGPUB	2004/08/27 10:36
-	95	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press or pressing or pressed or stamp\$3 or roll\$3 or die or master or emboss\$5))	USPAT; US-PGPUB	2004/08/27 10:42
-	77	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press or pressing or pressed or stamp\$3 or roll\$3 or die or master or emboss\$5)) not (((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex))) not ((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((press\$3 or stamp\$3 or roll\$3 or die or master) near7 (emboss\$5 or pattern\$3 or concave or convex)))	USPAT; US-PGPUB	2004/08/27 10:37
-	6	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (coat\$3 or deposit\$4 or film or layer or apply\$3 or application) with (benefi\$8 or advantag\$7 or prefer\$6 or optim\$6))	USPAT; US-PGPUB	2004/08/27 10:50
-	72	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (benefi\$8 or advantag\$7 or prefer\$6 or optim\$6))	USPAT; US-PGPUB	2004/08/27 10:57

-	66	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (benefi\$8 or advantag\$7 or prefer\$6 or optim\$6))) not ((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (coat\$3 or deposit\$4 or film or layer or apply\$3 or application) with (benefi\$8 or advantag\$7 or prefer\$6 or optim\$6)))	USPAT; US-PGPUB	2004/08/27 10:46
-	344	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (coat\$3 or deposit\$4 or film or layer or apply\$3 or application))	USPAT; US-PGPUB	2004/08/27 10:53
-	63	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (coat\$3 or deposit\$4 or film or layer or apply\$3 or application))) same (\$8acrylate or \$8acrylic or PMMA)	USPAT; US-PGPUB	2004/08/27 10:54
-	30	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition)) with (benefi\$8 or advantag\$7 or prefer\$6 or optim\$6))	EPO; JPO; DERWENT; IBM_TDB	2004/08/27 10:57
-	40	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (soften\$4)	USPAT; US-PGPUB	2004/08/27 11:08
-	13	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) with (soften\$4)	EPO; JPO; DERWENT; IBM_TDB	2004/08/27 11:09
-	34	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) and ((coat\$3 or deposit\$3 or apply\$3) with (monomer\$3 or oligomer\$2 or prepolymer\$2 or (pre adj polymer\$2)))	EPO; JPO; DERWENT; IBM_TDB	2004/08/30 08:05
-	42	((cure or cured or curing or harden\$3 or polymeriz\$5) with (temperature) with ((above or higher or greater) near5 (glass adj transition))) same ((coat\$3 or deposit\$3 or apply\$3) with (monomer\$3 or oligomer\$2 or prepolymer\$2 or (pre adj polymer\$2)))	USPAT; US-PGPUB	2004/08/27 11:14
-	1100	((cure or cured or curing or harden\$3 or polymeriz\$5)) same ((coat\$3 or deposit\$3 or apply\$3) with (monomer\$3 or oligomer\$2 or prepolymer\$2 or (pre adj polymer\$2))) same ((stamp\$5 or emboss\$5 or roll\$4 or die or press or pressed or pressing))	USPAT; US-PGPUB	2004/08/27 11:19
-	23	((cure or cured or curing or harden\$3 or polymeriz\$5)) same ((coat\$3 or deposit\$3 or apply\$3) with (monomer\$3 or oligomer\$2 or prepolymer\$2 or (pre adj polymer\$2))) same ((stamp\$5 or emboss\$5 or roll\$4 or die or press or pressed or pressing) near6 (pattern\$4 or convex or concave or indent\$6))	USPAT; US-PGPUB	2004/08/27 11:17

-	73	(((cure or cured or curing or harden\$3 or polymeriz\$5)) same ((coat\$3 or deposit\$3 or apply\$3) with (monomer\$3 or oligomer\$2 or prepolymer\$2 or (pre adj polymer\$2))) same ((stamp\$5 or emboss\$5 or roll\$4 or die or press or pressed or pressing))) and (((427/162,163.1,164,165).CCLS.) ((427/271).CCLS.) ((427/277,278).CCLS.) ((427/372.2,374.1,375,384,385.5,389.7).CCLS.) ((264/1.31,1.1,1.34,1.9).CCLS.) ((349/67,113).CCLS.))	USPAT; US-PGPUB	2004/08/27 11:19
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